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Caballé—Evaluation and Validation of the Virtualization of Live Collaborative Learning Sessions

Kurilovas and Serikoviene—New TFN Based Method for Evaluating Quality and Reusability of Learning Objects

Schagaev *et al.*—Multiple Choice Answers Approach: Assessment with Penalty Function for Computer Science and Similar Disciplines

Varela-Candamio and Garcia-Alvarez—Analysis of Information and Communication Technologies in Higher Education: A Case Study of Business Degree

Kurilovas and Zilinskiene—Evaluation of Quality of Personalised Learning Scenarios: An Improved MCEQLS AHP Method

Wautelet and Kolp—e-SPM: An Online Software Project Management Game

Bodea *et al.*—A Recommender Engine for Advanced Personalized Feedback in e-Learning Environments

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